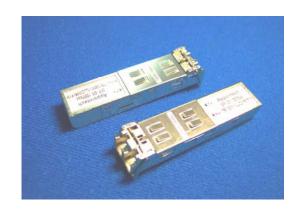


### **Features**

- Compliant with SFP MSA and SFF-8472(Rev 9.3)
- SFF-8472 Digital Diagnostic Monitoring Interface with real time monitors
  - Transmitter Output Power
  - Receiver Input Power
  - Laser Bias Current
  - Temperature
  - Supply Voltage
- Internal calibration for Digital Diagnostic Monitoring
- Alarms and warnings to indicate status of real time monitors
- Metal case & LC duplex receptacle with bail de-latch
- Transmitter disable input and receiver loss of signal output
- Wide operating temperature range -40°C~85°C
- Single 3.3V power supply
- AC coupled LVPECL compatible data input and output
- 2-wire serial EEPROM protocol



### **Specifications**

Parameter	Symbol	Min.	Тур.	Max.	Unit
Transmitter					
Data Rate (NRZ)	В	10	155	200	Mb/s
Optical Output Power (avg.) (1) (2)	P <sub>o</sub>	-9	-	-3	dBm
Extinction Ratio	ER	8.3	-	-	dB
Optical Wavelength	λc	830	850	860	nm
Spectral Width (RMS)	Δλ	-	-	0.85	nm
Output Rise Time (10-90%)	t <sub>r</sub> .	-	0.4	1	ns
Output Fall Time (10-90%)	t <sub>f</sub> .	-	1.0	1.5	ns
Data Differential Input Voltage	V.	500	-	2400	mV <sub>·p-p</sub> .
TX Fault Output Voltage	V <sub>FOL</sub> V <sub>FOH</sub>	0 2.4	-	0.4 Vcc	V
TX Disable Input Voltage	V <sub>DIL</sub> .	0 2	-	0.8 Vcc	V
Supply Voltage	Vcc	2.97	3.3	3.63	V
Supply Current	Icc	-	-	150	mA
Receiver					
Data Rate (NRZ)	В	50	155	200	Mb/s
Optical Input Sensitivity (avg.) (1) (4)	P. <sub>IN</sub> .	-	-35	-32	dBm
Saturation (avg. power)	P <sub>SAT</sub> .	0	-	-	dBm
Optical Wavelength	λ	770	850	860	nm
Output Rise Time (10-90%)	t <sub>r</sub> .	-	1.3	2.5	ns
Output Fall Time (10-90%)	t <sub>f</sub> .	-	1.6	2.5	ns



Parameter	Symbol	Min.	Тур.	Max.	Unit
Data Differential Output Voltage	V <sub>o</sub> .	370	-	2000	mV <sub>·p-p·</sub>
LOS Deasserted Power Level (avg.)	P <sub>-A</sub> -	-	-	-32	dBm
LOS Asserted Power Level (avg.)	P <sub>·D·</sub>	-45	-	-	dBm
LOS Hysteresis	P <sub>HYS</sub>	0.5	3	-	dB
LOS Output Voltage	V <sub>LOS-OL</sub>	0	-	0.4	\/
200 Odipat Voltage	V <sub>LOS-OH</sub>	2.4	-	Vcc	V
Supply Voltage	Vcc	2.97	3.3	3.63	V
Supply Current	Icc	-	-	130	mA

#### Notes:

- (1) With 0.275 NA, 62.5/125μm fiber.
- (2) Driven with a differential signal.
- (3) Eye mask diagram is compliant to ITU-T G.957 Eye Diagram.
   (4) 2<sup>23</sup> -1 PRBS, BER= 10<sup>-10</sup>.
   (5) The transmitter output should not be viewed directly.

**Absolute Maximum Ratings** 

Parameter	Min.	Max.	Unit
Operating Temperature	-40	85	°C
Storage Temperature	-40	100	°C
Lead Soldering Limits	-	240/10	°C /sec
Supply Voltage	-0.5	4	V

**Digital Diagnostic Monitor Characteristics** 

- 1311 = 13111 - 1 1 1 1 1 1							
Parameter	Min.	Unit					
Transceiver Internal Temperature Accuracy	±3.0	°C					
Transceiver Internal Supply Voltage Accuracy	±3	%					
TX Laser Bias Current Accuracy	±1 0	%					
TX Average Output Power Accuracy	±3.0	dB					
RX Average Input Power Accuracy	±3.0	dB					

Timing of Control and Status I/O

ining of Control and Status 1/0							
Parameter	Symbol	Min.	Max.	Unit	Condition		
TX Disable Assert Time	t_off		10	μs	Time from rising edge of TX Disable to when the optical output falls below 10% of nominal.		
TX Disable Negate Time	t_on		1	ms	Time from falling edge of TX Disable to when the modulated optical output rises above 90% of nominal.		
Time to initialize, including reset of TX_Fault	t_init		300	ms	From power on or negation of TX Fault using TX Disable.		
TX Fault Assert Time	t_fault		100	μs	Time from fault to TX fault on.		
TX Disable to reset	t_reset	10		μs	Time TX Disable must be held high to reset TX_fault.		
LOS Assert Time	t_loss_on		100	μs	Time from LOS state to RX LOS assert.		
LOS Deassert Time	t_loss_off		100	μs	Time from non-LOS state to RX LOS deassert.		
Serial ID Clock Rate	f_serial_clock		100	kHz			



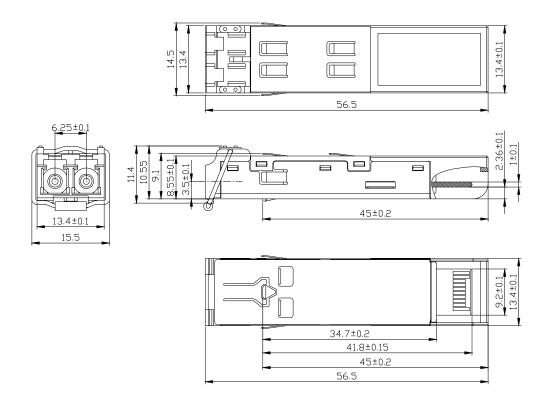
### **Ordering Information**

### TR85MM1-1VLC3MR1FDD

### **Operating Temperature Range:**

1:0°C ~ 70°C 2:-40°C ~ 85°C

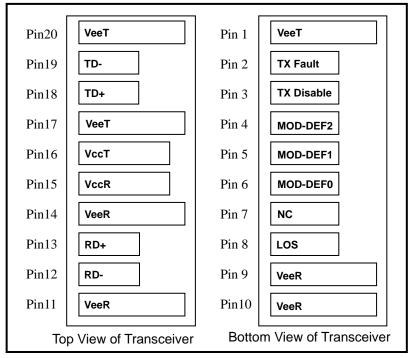
### **Outline Drawing**



UNIT: mm



### **SFP Transceiver Electrical Pad Layout**





**Pin Description** 

Pin Descri	Symbol	Description			
1	VeeT	Transmitter Ground			
2	TX Fault	Transmitter Fault Indication Logic Low indicates normal operation. Logic High Indicates a laser fault of some kind.  TX Fault is an open drain output, which should be pulled up with a 4.7K – 10KΩ resistor on the host board.			
3	TX Disable	Transmitter Disable  Its states are: $Low (0 - 0.8V) : Transmitter on$ $(>0.8, < 2.0V) : Undefined$ $High (2.0 - 3.465V) : Transmitter Disabled$ $Open : Transmitter Disabled$ It is pulled up within the module with a $4.7K - 10 \ K.\Omega$ resistor.  Module Definition 2 (SDA)			
4	MOD-DEF2	The data line of two wire serial interface for serial ID.  MOD-DEF2 should be pulled up with a 4.7K – 10KΩ resistor on the host board.  The pull-up voltage shall be VccT or VccR.			
5	MOD-DEF1	Module Definition 1 (SCL) The clock line of two wire serial interface for serial ID. MOD-DEF1 should be pulled up with a 4.7K – 10KΩ resistor on the host board. The pull-up voltage shall be VccT or VccR.			
6	MOD-DEF0	Module Definition 0 (WP) MOD-DEF0 is grounded by the module to indicate that the module is present.			
7	NC	Not connected			
8	LOS	Loss of Signal Logic High indicates the received optical power is below the worst-case receiver sensitivity. Logic Low indicates normal operation. LOS is an open drain output, which should be pulled up with a $4.7K-10K\Omega$ resistor on the host board.			
9	VeeR	Receiver Ground			
10	VeeR	Receiver Ground			
11	VeeR	Receiver Ground			
12	RD-	Inv. Received Data Out (Note 1)			
13 14	RD+ VeeR	Received Data Out (Note 1) Receiver Ground			
15	VeeR	Receiver Ground Receiver Power Supply			
16	VCCR	Transmitter Power Supply			
17	VeeT	Transmitter Ground			
18	TD+	Transmitter Data In (Note 2)			
19	TD-	Inv. Transmit Data In (Note 2)			
20	VeeT	Transmitter Ground			

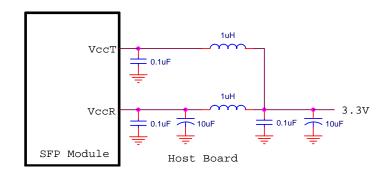
#### Notes:

1. RD+ and RD- are AC coupled  $100\Omega$  differential lines which should be terminated with  $100\Omega$  (differential) at the user SERDES. The AC coupling is done inside the module and is thus not required on the host board. The voltage swing on these lines will be between 370 and 2000 mV differential (185 – 1000 mV single ended) when properly terminated.

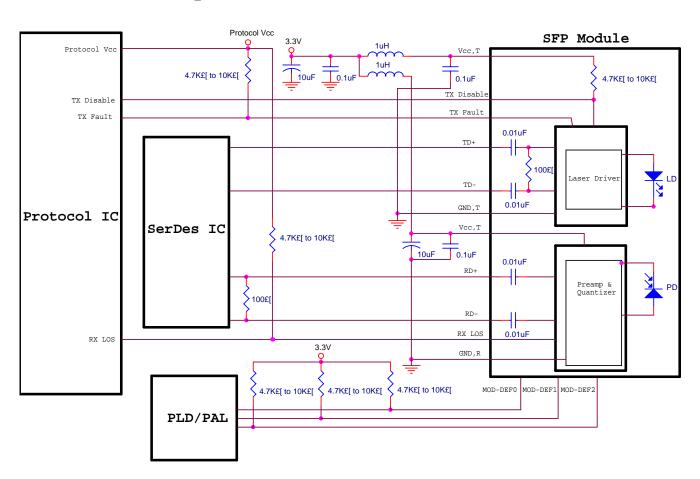


2. TD+ and TD- are AC-coupled, differential lines with  $100\Omega$  differential termination inside the module. The AC coupling is done inside the module and is thus not required on the host board. The inputs will accept differential swings of 500-2400 mV (250-1200 mV single-ended), though it is recommended that values between 500 and 1200 mV differential (250-600 mV single-ended) be used for best EMI performance.

### Recommended Host Board Supply Filtering Network



### Example SFP Host Board Schematic





## **Memory Map**

2 v	vire address 1010000X (A0h	) 2	wire address 1010001X (A2h)
0	Serial ID Defined by	0 55	Alarm and Warning Thresholds (56 bytes)
95	SFP MSA (96 bytes)	95	Cal Constants (40 bytes)
	Vendor Specific (32 bytes)	119	Real Time Diagnostic Interface (24 bytes)
127		127	Vendor Specific (8 bytes)
	Reserved in SFP MSA (128 bytes)		User Writable EEPROM (120 bytes)
	, , ,		ELI ROW (120 bytes)
255		247 255	Vendor Specific (8 bytes)



### **EEPROM Serial ID Memory Contents (A0h)**

Address	Hex	ASCII	Address	Hex	ASCII	Address	Hex	ASCII	Address	Hex	ASCII
0	03		32	20		64	00		96	20	
1	04		33	20		65	1A		97	20	
2	07		34	20		66	00		98	20	
3	00		35	20		67	00		99	20	
4	Note1		36	00		68			100	20	
5	Note1		37	20		69			101	20	
6	00		38	20		70			102	20	
7	00		39	20		71			103	20	
8	00		40	54	Т	72			104	20	
9	00		41	52	R	73			105	20	
10	00		42	38	8	74			106	20	
11	05		43	35	5	75	Note3		107	20	
12	02		44	4D	M	76	Notes		108	20	
13	00		45	4D	M	77			109	20	
14	Note1		46	33	1	78			110	20	
15	Note1		47	2D	-	79			111	20	
16	Note1		48	31	1	80			112	20	
17	Note1		49	56	V	81			113	20	
18	00		50	4C	L	82			114	20	
19	00		51	43	С	83			115	20	
20	41	Α	52	33	3	84			116	20	
21	50	Р	53	4D	M	85			117	20	
22	50	Р	54	52	R	86			118	20	
23	4F	0	55	31	1	87	Note4		119	20	
24	49		56	46	F	88	NOIE4		120	20	
25	4E	N	57	20		89			121	20	
26	54	Т	58	20		90			122	20	
27	45	Е	59	20		91			123	20	
28	43	С	60	Note1		92	68		124	20	
29	48	Η	61	Note1		93	B0		125	20	
30	20		62	00		94	01		126	20	
31	20		63	Note2		95	Note2		127	20	

#### Notes:

- 1. Data will vary depends on product.
- 2. Addresses 63 is check sum of bytes 0 62. Addresses 95 is check sum of bytes 64 94.
- 3. These addresses are reserved for serial number information.
- 4. These addresses are reserved for date code information.
- 5. The data transfer protocol and complete description of A0h memory contents are defined in SFP MSA and SFF-8472.



### **Digital Diagnostic**

Alarm and Warning Thresholds (2-Wire Address A2h)

Address	#Bytes	Name	Description	Value
00-01	2	Temp High Alarm	MBS at low address	100°C
02-03	2	Temp Low Alarm	MBS at low address	-40°C
04-05	2	Temp High Warning	MBS at low address	+85°C
06-07	2	Temp Low Warning	MBS at low address	-35°C
08-09	2	Voltage High Alarm	MBS at low address	3.9V
10-11	2	Voltage Low Alarm	MBS at low address	2.7V
12-13	2	Voltage High Warning	MBS at low address	3.63V
14-15	2	Voltage Low Warning	MBS at low address	2.97V
16-17	2	Bias High Alarm	MBS at low address	10mA
18-19	2	Bias Low Alarm	MBS at low address	1mA
20-21	2	Bias High Warning	MBS at low address	9mA
22-23	2	Bias Low Warning	MBS at low address	1mA
24-25	2	TX Power High Alarm	MBS at low address	Note
26-27	2	TX Power Low Alarm	MBS at low address	Note
28-29	2	TX Power High Warning	MBS at low address	Note
30-31	2	TX Power LOW Warning	MBS at low address	Note
32-33	2	RX Power High Alarm	MBS at low address	Note
34-35	2	RX Power Low Alarm	MBS at low address	Note
36-37	2	RX Power High Warning	MBS at low address	Note
38-39	2	RX Power Low Warning	MBS at low address	Note
40-55	16	Reserved	Reserved for future monitored quantities.	

Note: Data value will vary depends on product.



### Calibration constants for External Calibration Option (2-Wire Address A2h)

Address	#Bytes	Name	Description	Value (Note)
56-59	4	Rx_PWR(4)	Single precision floating point calibration data - Rx optical power.	0
60-63	4	Rx_PWR(3)	Single precision floating point calibration data - Rx optical power.	0
64-67	4	Rx_PWR(2)	Single precision floating point calibration data, Rx optical power.	0
68-71	4	Rx_PWR(1)	Single precision floating point calibration data, Rx optical power.	1
72-75	4	Rx_PWR(0)	Single precision floating point calibration data, Rx optical power.	0
76-77	2	Tx_I(Slope)	Fixed decimal (unsigned) calibration data, laser bias current.	1
78-79	2	Tx_I(Offset)	Fixed decimal (signed two's complement) calibration data, laser bias current.	0
80-81	2	Tx_PWR(Slope)	Fixed decimal (unsigned) calibration data, transmitter coupled output power.	1
82-83	2	Tx_PWR(Offset)	Fixed decimal (signed two's complement) calibration data, transmitter coupled output power.	0
84-85	2	T (Slope)	Fixed decimal (unsigned) calibration data, internal module temperature.	1
86-87	2	T (Offset)	Fixed decimal (signed two's complement) calibration data, internal module temperature.	0
88-89	2	V (Slope)	Fixed decimal (unsigned) calibration data, internal module supply voltage.	1
90-91	2	V (Offset)	Fixed decimal (signed two's complement) calibration data, internal module supply voltage.	
92-94	3	Reserved	Reserved	
95	1	Checksum	Byte 95 contains the low order 8 bits of the sum of bytes 0 – 94.	

Notes: The device is internally calibrated.



A/D Values and Status Bits (2-Wire Address A2h)

Byte	Bit	Name	Description				
Converted analog values. Calibrated 16 bit data.							
96	All	Temperature MSB	Internally measured module temperature.				
97	All	Temperature LSB					
98	All	Vcc MSB	Internally measured supply voltage in transceiver.				
99	All	Vcc LSB					
100	All	TX Bias MSB	Internally measured TX Bias Current				
101	All	TX Bias LSB					
102	All	TX Power MSB	Measured TX output power.				
103	All	TX Power LSB					
104	All	RX Power MSB	Measured RX input power.				
105	All	RX Power LSB					
106	All	Reserved MSB	Reserved for 1 <sup>st</sup> future definition of digitized analog input				
107	All	Reserved LSB	Reserved for 1 <sup>st</sup> future definition of digitized analog input  Reserved for 2 <sup>nd</sup> future definition of				
108	All	Reserved MSB	Reserved for 2 <sup>nd</sup> future definition of digitized analog input  Reserved for 2 <sup>nd</sup> future definition of				
109	All	Reserved LSB	Reserved for 2 <sup>nd</sup> future definition of digitized analog input				
Option	al Stat	tus/Control Bits					
110	7	Tx Disable State	Digital state of the TX Disable Input Pin.				
110	6	Soft Tx Disable	Read/write bit that allows software disable of laser. It is not implemented, the transceiver ignores the value of this bit.				
110	5	Reserved	Reserved				
110	4	RX Rate Select State	Digital state of the SFP RX Rate Select Input Pin.				
110	3	Soft RX Rate Select	Read/write bit that allows software RX rate select. It is not implemented.				
110	2	TX Fault	Digital state of the TX Fault Output Pin.				
110	1	LOS	Digital state of the LOS Output Pin.				
110	0	Data_Ready_Bar	Indicates transceiver has achieved power up and data is ready.				
111	7-0	Reserved	Reserved				



## Alarm and Warning Flag Bits (2-Wire Address A2h)

Byte	Bit	Name	Description
Reserv	ed Op	tional Alarm and Warning	Flag Bits
112	7	Temp High Alarm	Set when internal temperature exceeds high alarm level.
112	6	Temp Low Alarm	Set when internal temperature is below low alarm level.
112	5	Vcc High Alarm	Set when internal supply voltage exceeds high alarm level.
112	4	Vcc Low Alarm	Set when internal supply voltage is below low alarm level.
112	3	TX Bias High Alarm	Set when TX Bias current exceeds high alarm level.
112	2	TX Bias Low Alarm	Set when TX Bias current is below low alarm level.
112	1	TX Power High Alarm	Set when TX output power exceeds high alarm level.
112	0	TX Power Low Alarm	Set when TX output power is below low alarm level.
113	7	RX Power High Alarm	Set when Received Power exceeds high alarm level.
113	6	RX Power Low Alarm	Set when Received Power is below low alarm level.
113	5	Reserved Alarm	
113	4	Reserved Alarm	
113	3	Reserved Alarm	
113	2	Reserved Alarm	
113	1	Reserved Alarm	
113	0	Reserved Alarm	
114	All	Reserved	
115	All	Reserved	
116	7	Temp High Warning	Set when internal temperature exceeds high warning level.
116	6	Temp Low Warning	Set when internal temperature is below low warning level.
116	5	Vcc High Warning	Set when internal supply voltage exceeds high warning level.
116	4	Vcc Low Warning	Set when internal supply voltage is below low warning level.
116	3	TX Bias High Warning	Set when TX Bias current exceeds high warning level.
116	2	TX Bias Low Warning	Set when TX Bias current is below low warning level.
116	1	TX Power High Warning	Set when TX output power exceeds high warning level.
116	0	TX Power Low Warning	Set when TX output power is below low warning level.
117	7	RX Power High Warning	Set when Received Power exceeds high warning level.
117	6	RX Power Low Warning	Set when Received Power is below low warning level.
117	5	Reserved Warning	
117	4	Reserved Warning	
117	3	Reserved Warning	_
117	2	Reserved Warning	
117	1	Reserved Warning	
117	0	Reserved Warning	
118	All	Reserved	



### Vendor Specific Memory Addresses (2-Wire Address A2h)

Byte	Bit	Name	Description
120-127	All	Vendor Specific	Vendor Specific

### **User EEPROM (2-Wire Address A2h)**

Address	#Bytes	Name	Description
128-247	120	User EEPROM	User writable EEPROM
248-255	8	Vendor Specific	Vendor specific control functions

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